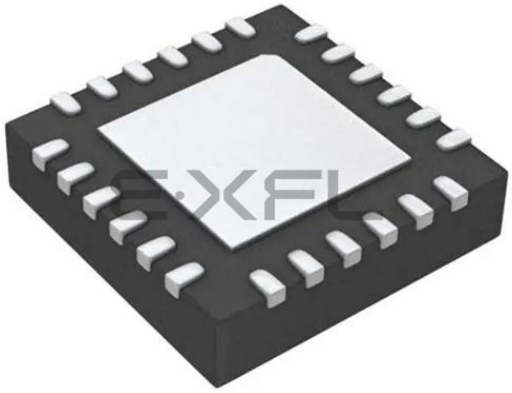

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	CIP-51 8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I²C), SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	17
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 10x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	24-WFQFN Exposed Pad
Supplier Device Package	24-QFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f986-gm

List of Tables

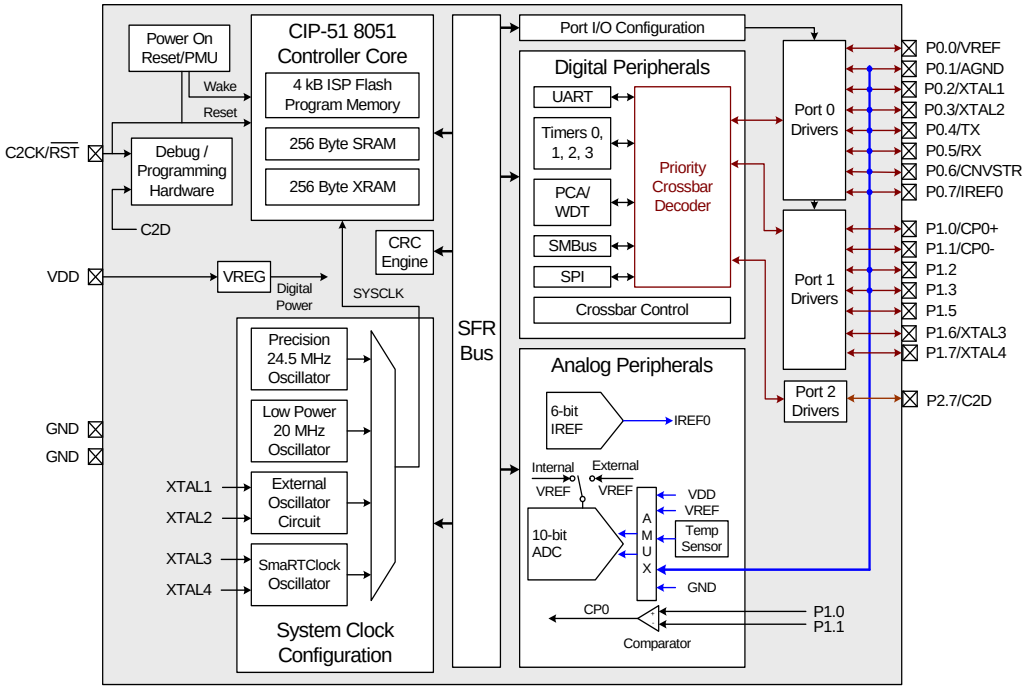


Figure 1.3. C8051F982 Block Diagram

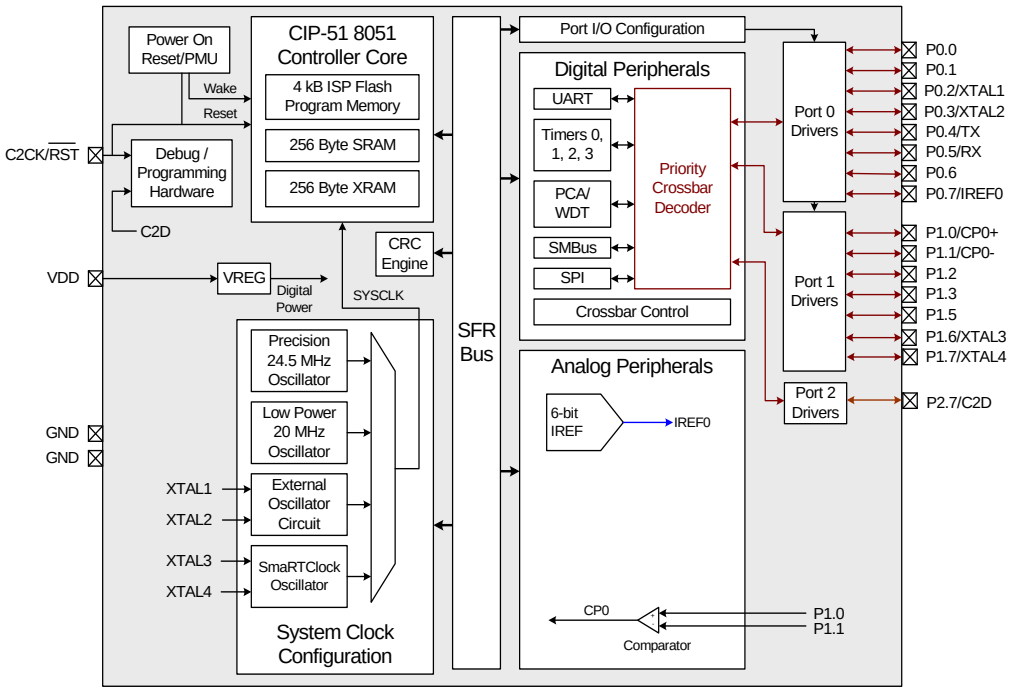


Figure 1.4. C8051F983 Block Diagram

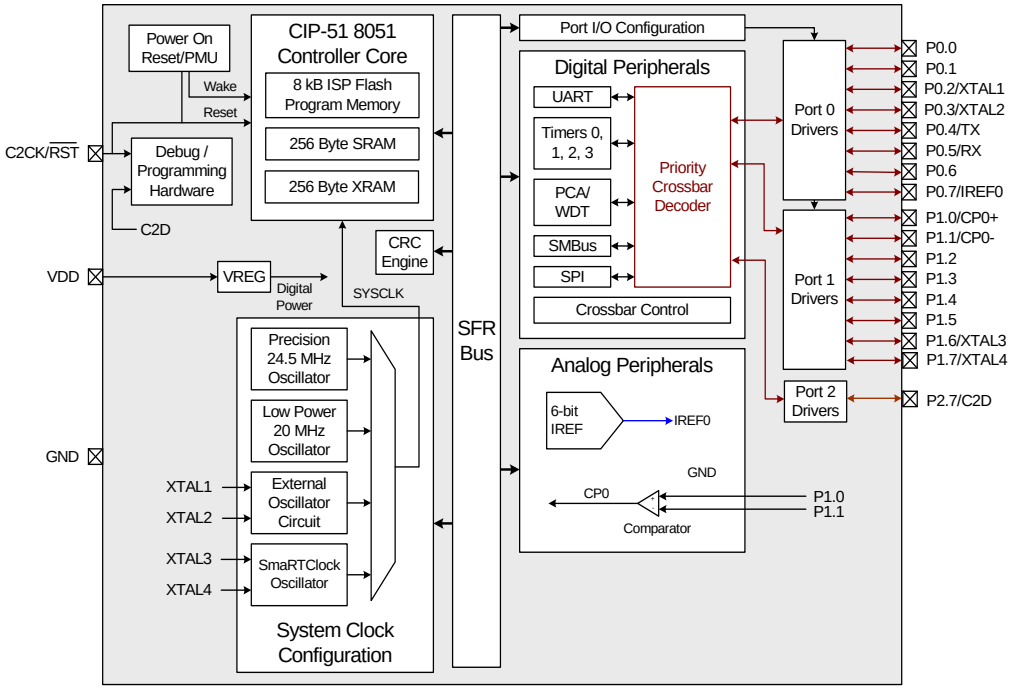


Figure 1.7. C8051F987 Block Diagram

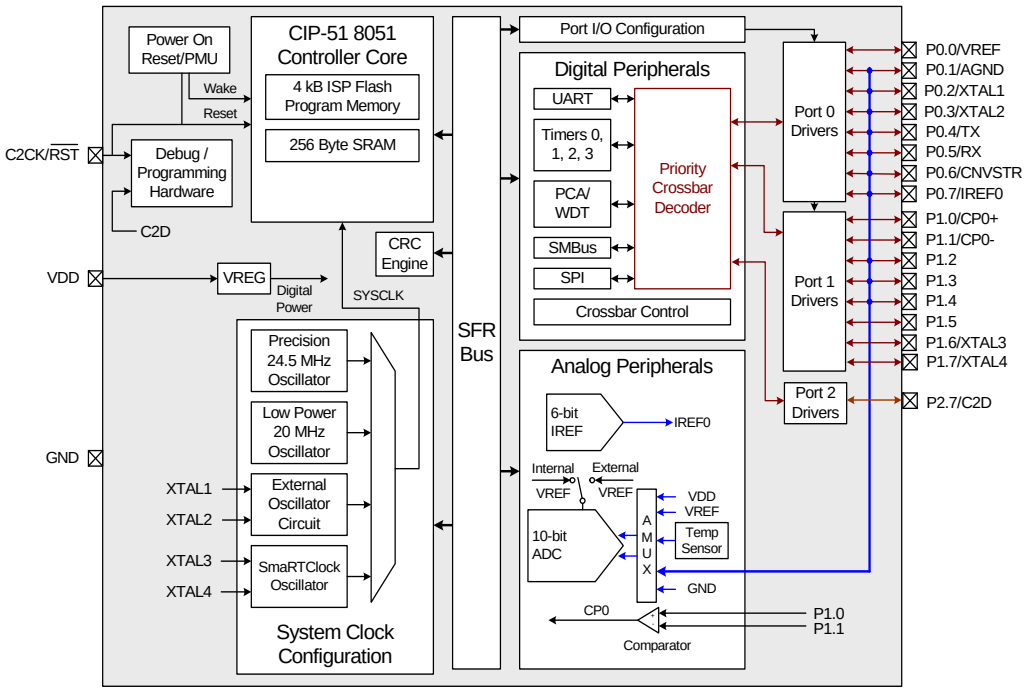
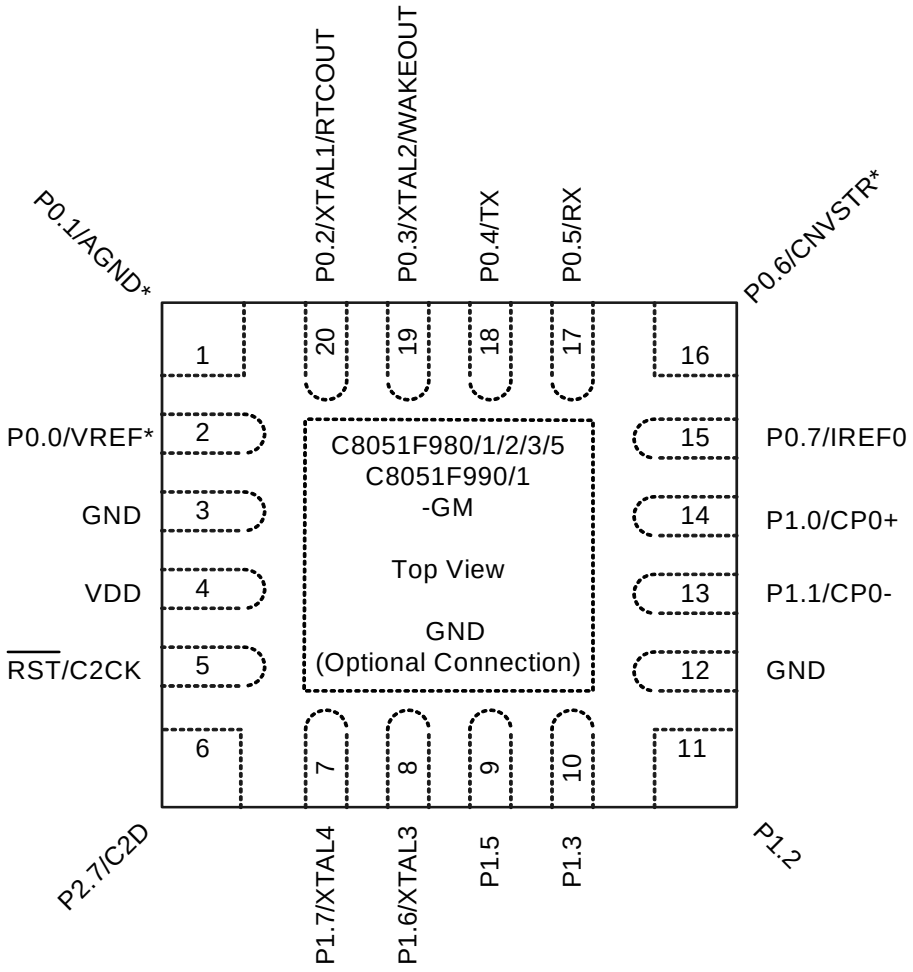


Figure 1.8. C8051F988 Block Diagram

3. Pinout and Package Definitions

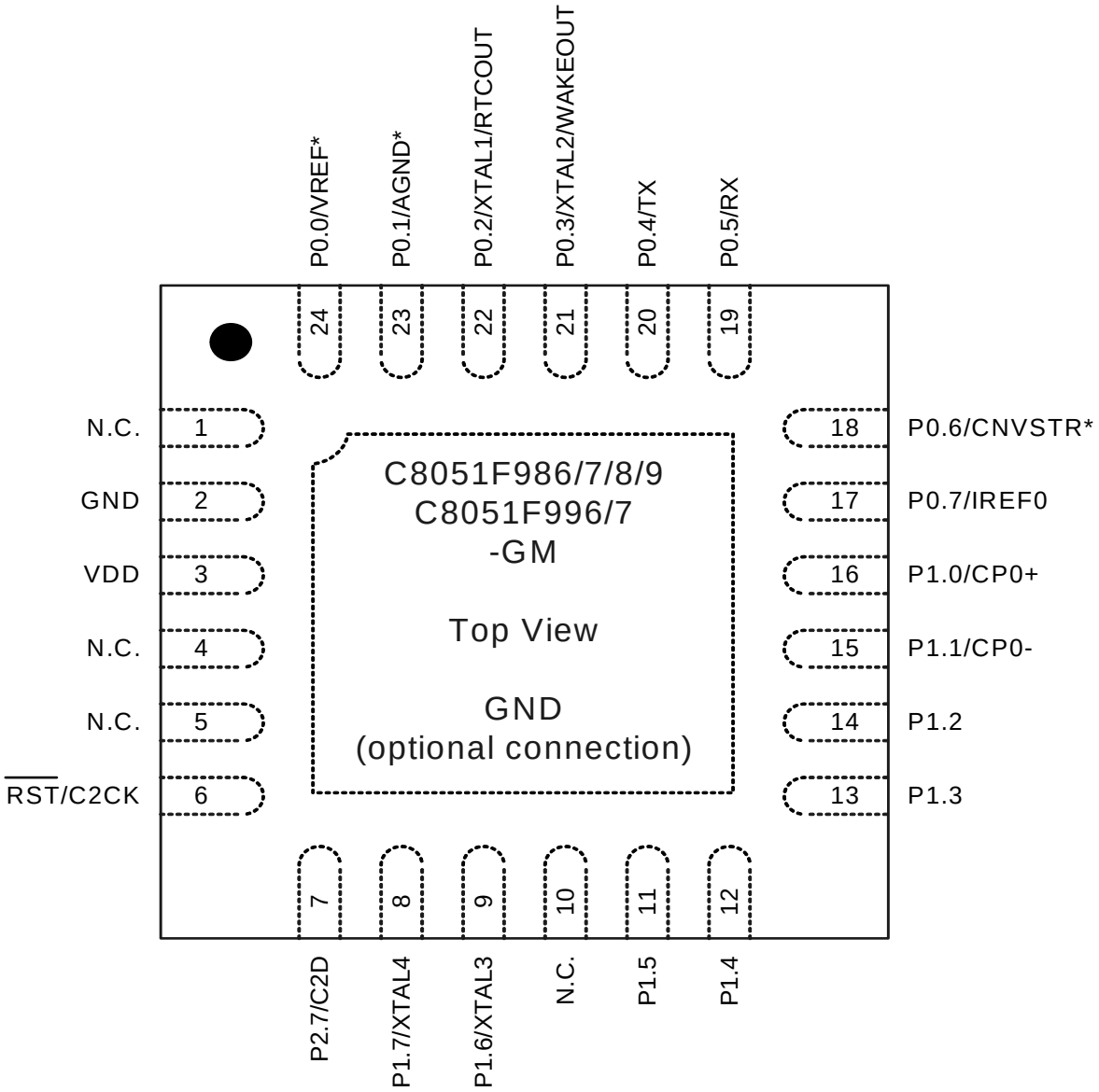
Table 3.1. Pin Definitions for the C8051F99x-C8051F98x

Name	Pin Numbers			Type	Description
	‘F980/1/2 ‘F983/5 ‘F990/1 -GM	‘F986/7 ‘F988/9 ‘F996/7 -GM	‘F986/7 ‘F988/9 ‘F996/7 -GU		
V_{DD}	4	3	6	P In	Power Supply Voltage. Must be 1.8 to 3.6 V.
GND	3, 12	2	5	G	Required Ground.
$\overline{RST}$/ C2CK	5	6	9	D I/O D I/O	Device Reset. Open-drain output of internal POR or V_{DD} monitor. An external source can initiate a system reset by driving this pin low for at least 15 µs. A 1 kΩ to 5 kΩ pullup to V_{DD} is recommended. See Section “18. Reset Sources” on page 181 Section for a complete description. Clock signal for the C2 Debug Interface.
P2.7/ C2D	6	7	10	D I/O D I/O	Port 2.7. This pin can only be used as GPIO. The Crossbar cannot route signals to this pin and it cannot be configured as an analog input. See Port I/O Section for a complete description. Bi-directional data signal for the C2 Debug Interface.
P1.6/ XTAL3	8	9	12	D I/O A In	Port 1.6. See Port I/O Section for a complete description. SmaRTClock Oscillator Crystal Input. See Section 20 for a complete description.
P1.7/ XTAL4	7	8	11	D I/O A Out	Port 1.7. See Port I/O Section for a complete description. SmaRTClock Oscillator Crystal Output. See Section 20 for a complete description.
P0.0/ V_{REF}*	2	24	3	D I/O or A In A In	Port 0.0. See Port I/O Section for a complete description. External V_{REF} Input. See Section “5.9. Voltage and Ground Reference Options” on page 88.
***Note:** Available only on the C8051F980/2/6/8 and C8051F990/6 devices.					



***Note:** Signal only available on ‘F980, ‘F982 and ‘F990 devices.

Figure 3.1. QFN-20 Pinout Diagram (Top View)



***Note:** Signal only available on ‘F986, ‘F988, and ‘F996 devices.

Figure 3.2. QFN-24 Pinout Diagram (Top View)

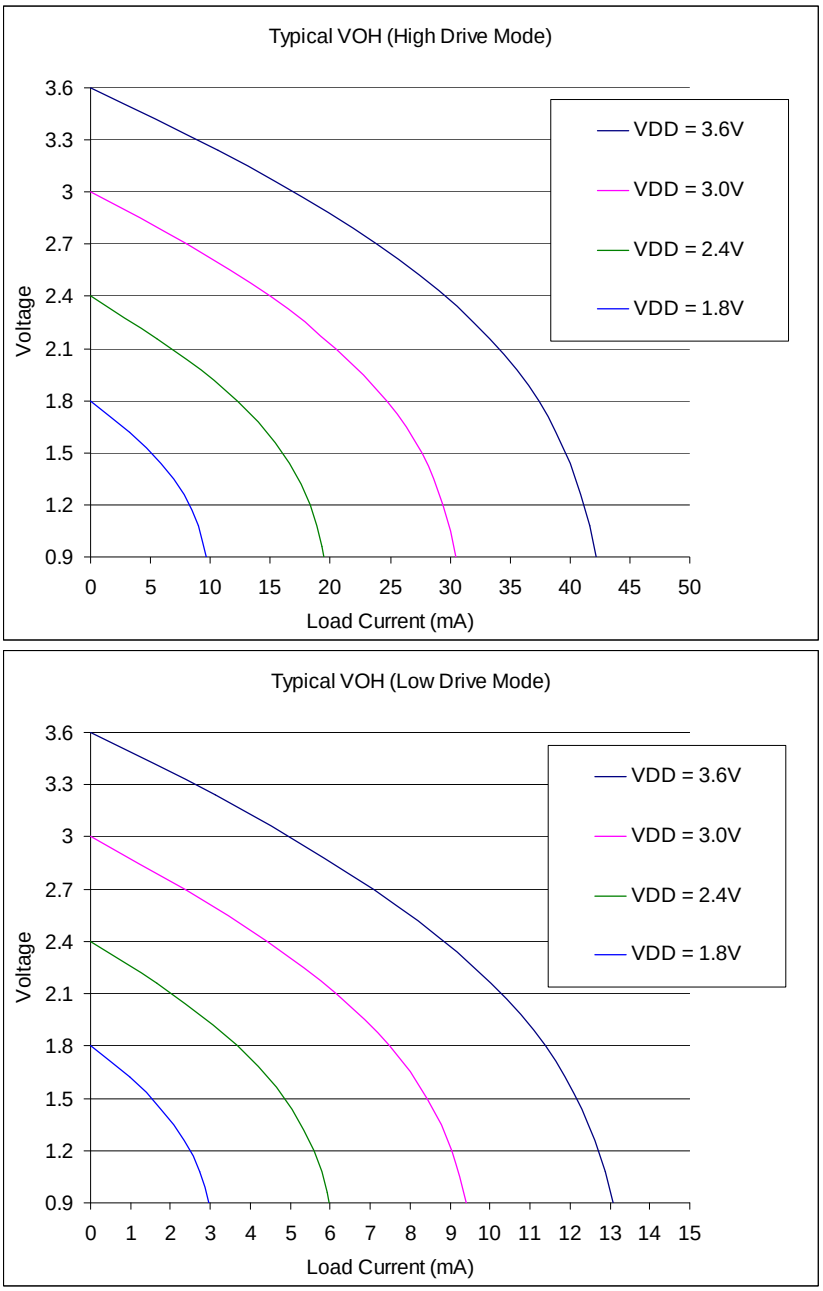


Figure 4.3. Typical VOH Curves, 1.8–3.6 V

Table 4.5. Power Management Electrical Specifications

V_{DD} = 1.8 to 3.6 V, –40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Idle Mode Wake-up Time		2	—	3	SYSCLKs
Suspend Mode Wake-up Time	CLKDIV = 0x00 Low Power or Precision Osc.	—	400	—	ns
Sleep Mode Wake-up Time		—	2	—	µs

Table 4.6. Flash Electrical Characteristics

V_{DD} = 1.8 to 3.6 V, –40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Flash Size	C8051F980/1/6/7, C8051F990/1/6/7	8192	—	—	bytes
	C8051F982/3/8/9	4096	—	—	bytes
	C8051F985	2048	—	—	bytes
Endurance		20 k	100k	—	Erase/Write Cycles
Erase Cycle Time		28	32	36	ms
Write Cycle Time		57	64	71	µs

Table 4.7. Internal Precision Oscillator Electrical Characteristics

V_{DD} = 1.8 to 3.6 V; T_A = –40 to +85 °C unless otherwise specified; Using factory-calibrated settings.

Parameter	Conditions	Min	Typ	Max	Units
Oscillator Frequency	–40 to +85 °C, V_{DD} = 1.8–3.6 V	24	24.5	25	MHz
Oscillator Supply Current (from V_{DD})	25 °C; includes bias current of 90–100 µA	—	300*	—	µA
***Note:** Does not include clock divider or clock tree supply current.					

Table 4.8. Internal Low-Power Oscillator Electrical Characteristics

V_{DD} = 1.8 to 3.6 V; T_A = –40 to +85 °C unless otherwise specified; Using factory-calibrated settings.

Parameter	Conditions	Min	Typ	Max	Units
Oscillator Frequency	–40 to +85 °C, V_{DD} = 1.8–3.6 V	18	20	22	MHz
Oscillator Supply Current (from V_{DD})	25 °C No separate bias current required	—	100*	—	µA
***Note:** Does not include clock divider or clock tree supply current.					

5.2.3. Burst Mode

Burst Mode is a power saving feature that allows ADC0 to remain in a low power state between conversions. When Burst Mode is enabled, ADC0 wakes from a low power state, accumulates 1, 4, 8, 16, 32, or 64 using an internal Burst Mode clock (approximately 20 MHz), then re-enters a low power state. Since the Burst Mode clock is independent of the system clock, ADC0 can perform multiple conversions then enter a low power state within a single system clock cycle, even if the system clock is slow (e.g. 32.768 kHz), or suspended.

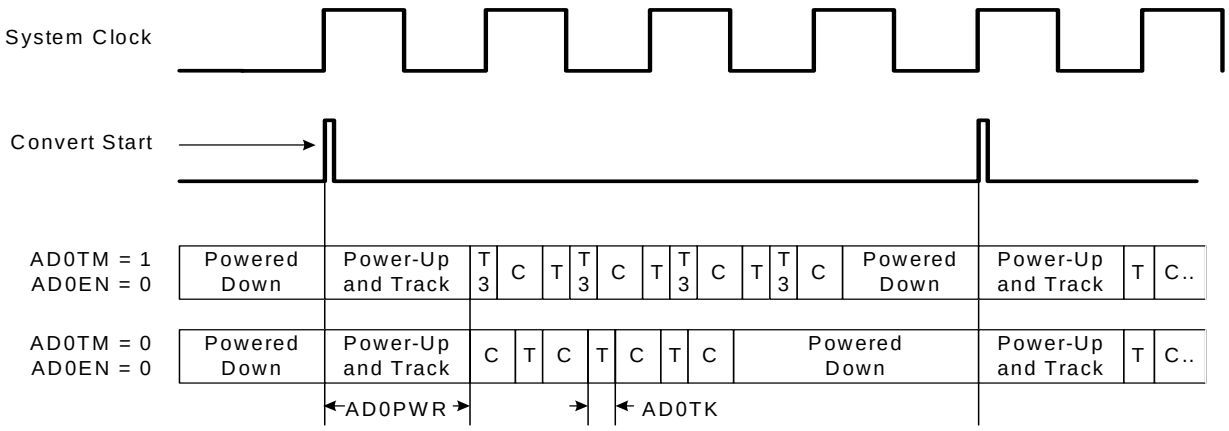
Burst Mode is enabled by setting BURSTEN to logic 1. When in Burst Mode, AD0EN controls the ADC0 idle power state (i.e. the state ADC0 enters when not tracking or performing conversions). If AD0EN is set to logic 0, ADC0 is powered down after each burst. If AD0EN is set to logic 1, ADC0 remains enabled after each burst. On each convert start signal, ADC0 is awakened from its Idle Power State. If ADC0 is powered down, it will automatically power up and wait the programmable Power-Up Time controlled by the AD0PWR bits. Otherwise, ADC0 will start tracking and converting immediately. Figure 5.3 shows an example of Burst Mode Operation with a slow system clock and a repeat count of 4.

When Burst Mode is enabled, a single convert start will initiate a number of conversions equal to the repeat count. When Burst Mode is disabled, a convert start is required to initiate each conversion. In both modes, the ADC0 End of Conversion Interrupt Flag (AD0INT) will be set after “repeat count” conversions have been accumulated. Similarly, the Window Comparator will not compare the result to the greater-than and less-than registers until “repeat count” conversions have been accumulated.

In Burst Mode, tracking is determined by the settings in AD0PWR and AD0TK. The default settings for these registers will work in most applications without modification; however, settling time requirements may need adjustment in some applications. Refer to “5.2.4. Settling Time Requirements” on page 71 for more details.

Notes:

- Setting AD0TM to 1 will insert an additional 3 SAR clocks of tracking before each conversion, regardless of the settings of AD0PWR and AD0TK.
- When using Burst Mode, care must be taken to issue a convert start signal no faster than once every four SYSCLK periods. This includes external convert start signals.



T = Tracking set by AD0TK
T3 = Tracking set by AD0TM (3 SAR clocks)
C = Converting

Figure 5.3. Burst Mode Tracking Example with Repeat Count Set to 4

SFR Definition 8.1. CS0CN: Capacitive Sense Control

Bit	7	6	5	4	3	2	1	0
Name	CS0EN	CS0EOS	CS0INT	CS0BUSY	CS0CMPEN	Reserved	CS0PME	CS0CMPF
Type	R/W	R	R/W	R/W	R/W	R	R	R
Reset	0	0	0	0	0	0	0	0

SFR Page = 0x0; SFR Address = 0xB0

Bit	Name	Description
7	CS0EN	**CS0 Enable.** 0: CS0 disabled and in low-power mode. 1: CS0 enabled and ready to convert.
6	CS0EOS	**CS0 End of Scan Interrupt Flag.** 0: CS0 has not completed a scan since the last time CS0EOS was cleared. 1: CS0 has completed a scan. This bit is not automatically cleared by hardware.
5	CS0INT	**CS0 Interrupt Flag.** 0: CS0 has not completed a data conversion since the last time CS0INT was cleared. 1: CS0 has completed a data conversion. This bit is not automatically cleared by hardware.
4	CS0BUSY	**CS0 Busy.** Read: 0: CS0 conversion is complete or a conversion is not currently in progress. 1: CS0 conversion is in progress. Write: 0: No effect. 1: Initiates CS0 conversion if CS0CM[2:0] = 000b, 110b, or 111b.
3	CS0CMPEN	**CS0 Digital Comparator Enable Bit.** Enables the digital comparator, which compares accumulated CS0 conversion output to the value stored in CS0THH:CS0THL. 0: CS0 digital comparator disabled. 1: CS0 digital comparator enabled.
2	Reserved	Read = Varies.
1	CS0PME	**CS0 Pin Monitor Event.** Set if any converter re-tries have occurred due to a pin monitor event. This bit remains set until cleared by firmware.
0	CS0CMPF	**CS0 Digital Comparator Interrupt Flag.** 0: CS0 result is smaller than the value set by CS0THH and CS0THL since the last time CS0CMPF was cleared. 1: CS0 result is greater than the value set by CS0THH and CS0THL since the last time CS0CMPF was cleared.

12. Special Function Registers

The direct-access data memory locations from 0x80 to 0xFF constitute the special function registers (SFRs). The SFRs provide control and data exchange with the C8051F99x-C8051F98x's resources and peripherals. The CIP-51 controller core duplicates the SFRs found in a typical 8051 implementation as well as implementing additional SFRs used to configure and access the sub-systems unique to the C8051F99x-C8051F98x. This allows the addition of new functionality while retaining compatibility with the MCS-51™ instruction set. Table 12.1 and Table 12.2 list the SFRs implemented in the C8051F99x-C8051F98x device family.

The SFR registers are accessed anytime the direct addressing mode is used to access memory locations from 0x80 to 0xFF. SFRs with addresses ending in 0x0 or 0x8 (e.g., P0, TCON, SCON0, IE, etc.) are bit-addressable as well as byte-addressable. All other SFRs are byte-addressable only. Unoccupied addresses in the SFR space are reserved for future use. Accessing these areas will have an indeterminate effect and should be avoided. Refer to the corresponding pages of the data sheet, as indicated in Table 12.3, for a detailed description of each register.

Table 12.1. Special Function Register (SFR) Memory Map (Page 0x0)

F8	SPI0CN	PCA0L	PCA0H	PCA0CPL0	PCA0CPH0	CS0THL	CS0THH	VDM0CN
F0	B	P0MDIN	P1MDIN	CS0MD2	SMB0ADR	SMB0ADM	EIP1	EIP2
E8	ADC0CN	PCA0CPL1	PCA0CPH1	PCA0CPL2	PCA0CPH2	CS0DL	CS0DH	RSTSRC
E0	ACC	XBR0	XBR1	XBR2	IT01CF	FLWR	EIE1	EIE2
D8	PCA0CN	PCA0MD	PCA0CPM0	PCA0CPM1	PCA0CPM2	CS0SS	CS0SE	PCA0PWM
D0	PSW	REF0CN	CS0SCAN0	CS0SCAN1	P0SKIP	P1SKIP	IREF0CN	P0MAT
C8	TMR2CN	REG0CN	TMR2RLL	TMR2RLH	TMR2L	TMR2H	PMU0FL	P1MAT
C0	SMB0CN	SMB0CF	SMB0DAT	ADC0GTL	ADC0GTH	ADC0LTL	ADC0LTH	P0MASK
B8	IP	IREF0CN	ADC0AC	ADC0PWR	ADC0TK	ADC0L	ADC0H	P1MASK
B0	CS0CN	OSCXCN	OSCICN	OSCICL		PMU0CF	FLSCL	FLKEY
A8	IE	CLKSEL	CS0CF	CS0MX	RTC0ADR	RTC0DAT	RTC0KEY	CS0MD1
A0	P2	SPI0CFG	SPI0CKR	SPI0DAT	P0MDOUT	P1MDOUT	P2MDOUT	SFRPAGE
98	SCON0	SBUF0	CRC0CNT	CPT0CN	CRC0FLIP	CPT0MD	CRC0AUTO	CPT0MX
90	P1	TMR3CN	TMR3RLL	TMR3RLH	TMR3L	TMR3H	ADC0MX	ADC0CF
88	TCON	TMOD	TL0	TL1	TH0	TH1	CKCON	PSCTL
80	P0	SP	DPL	DPH	CRC0CN	CRC0IN	CRC0DAT	PCON
	0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)

(bit addressable)

Table 12.3. Special Function Registers (Continued)

SFRs are listed in alphabetical order. All undefined SFR locations are reserved.

Register	Address	SFR Page	Description	Page
P1SKIP	0xD5	0x0	Port 1 Skip	231
P2	0xA0	All	Port 2 Latch	233
P2DRV	0x9D	0xF	Port 2 Drive Strength	234
P2MDOUT	0xA6	0x0	Port 2 Output Mode Configuration	234
PCA0CN	0xD8	0x0	PCA0 Control	313
PCA0CPH0	0xFC	0x0	PCA0 Capture 0 High	318
PCA0CPH1	0xEA	0x0	PCA0 Capture 1 High	318
PCA0CPH2	0xEC	0x0	PCA0 Capture 2 High	318
PCA0CPL0	0xFB	0x0	PCA0 Capture 0 Low	318
PCA0CPL1	0xE9	0x0	PCA0 Capture 1 Low	318
PCA0CPL2	0xEB	0x0	PCA0 Capture 2 Low	318
PCA0CPM0	0xDA	0x0	PCA0 Module 0 Mode Register	316
PCA0CPM1	0xDB	0x0	PCA0 Module 1 Mode Register	316
PCA0CPM2	0xDC	0x0	PCA0 Module 2 Mode Register	316
PCA0H	0xFA	0x0	PCA0 Counter High	317
PCA0L	0xF9	0x0	PCA0 Counter Low	317
PCA0MD	0xD9	0x0	PCA0 Mode	314
PCA0PWM	0xDF	0x0	PCA0 PWM Configuration	315
PCON	0x87	All	Power Control	171
PMU0CF	0xB5	0x0	PMU0 Configuration	168
PMU0FL	0xCE	0x0	PMU0 Flag Register	169
PMU0MD	0xB5	0xF	PMU0 Mode	170
PSCTL	0x8F	All	Program Store R/W Control	159
PSW	0xD0	All	Program Status Word	127
REF0CN	0xD1	0x0	Voltage Reference Control	90
REG0CN	0xC9	0x0	Voltage Regulator (REG0) Control	180
REVID	0xE2	0xF	Revision ID	155
RSTSRC	0xEF	0x0	Reset Source Configuration/Status	187
RTC0ADR	0xAC	0x0	RTC0 Address	202
RTC0DAT	0xAD	0x0	RTC0 Data	202
RTC0KEY	0xAE	0x0	RTC0 Key	201
SBUF0	0x99	0x0	UART0 Data Buffer	263
SCON0	0x98	0x0	UART0 Control	262
SFRPAGE	0xA7	All	SFR Page	134
SMB0ADM	0xF5	0x0	SMBus Slave Address Mask	247
SMB0ADR	0xF4	0x0	SMBus Slave Address	247
SMB0CF	0xC1	0x0	SMBus0 Configuration	242
SMB0CN	0xC0	0x0	SMBus0 Control	244
SMB0DAT	0xC2	0x0	SMBus0 Data	248
SP	0x81	All	Stack Pointer	126
SPI0CFG	0xA1	0x0	SPI0 Configuration	272
SPI0CKR	0xA2	0x0	SPI0 Clock Rate Control	274
SPI0CN	0xF8	0x0	SPI0 Control	273
SPI0DAT	0xA3	0x0	SPI0 Data	274

SFR Definition 13.4. EIP1: Extended Interrupt Priority 1

Bit	7	6	5	4	3	2	1	0
Name	PT3		PCP0	PPCA0	PADC0	PWADC0	PRTC0A	PSMB0
Type	R/W	R	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Page = All; SFR Address = 0xF6

Bit	Name	Function
7	PT3	**Timer 3 Interrupt Priority Control.** This bit sets the priority of the Timer 3 interrupt. 0: Timer 3 interrupts set to low priority level. 1: Timer 3 interrupts set to high priority level.
6	Unused	Read = 0b. Write = Don't care.
5	PCP0	**Comparator0 (CP0) Interrupt Priority Control.** This bit sets the priority of the CP0 interrupt. 0: CP0 interrupt set to low priority level. 1: CP0 interrupt set to high priority level.
4	PPCA0	**Programmable Counter Array (PCA0) Interrupt Priority Control.** This bit sets the priority of the PCA0 interrupt. 0: PCA0 interrupt set to low priority level. 1: PCA0 interrupt set to high priority level.
3	PADC0	**ADC0 Conversion Complete Interrupt Priority Control.** This bit sets the priority of the ADC0 Conversion Complete interrupt. 0: ADC0 Conversion Complete interrupt set to low priority level. 1: ADC0 Conversion Complete interrupt set to high priority level.
2	PWADC0	**ADC0 Window Comparator Interrupt Priority Control.** This bit sets the priority of the ADC0 Window interrupt. 0: ADC0 Window interrupt set to low priority level. 1: ADC0 Window interrupt set to high priority level.
1	PRTC0A	**SmaRTClock Alarm Interrupt Priority Control.** This bit sets the priority of the SmaRTClock Alarm interrupt. 0: SmaRTClock Alarm interrupt set to low priority level. 1: SmaRTClock Alarm interrupt set to high priority level.
0	PSMB0	**SMBus (SMB0) Interrupt Priority Control.** This bit sets the priority of the SMB0 interrupt. 0: SMB0 interrupt set to low priority level. 1: SMB0 interrupt set to high priority level.

14.1.2. Flash Erase Procedure

The Flash memory is organized in 512-byte pages. The erase operation applies to an entire page (setting all bytes in the page to 0xFF). To erase an entire Flash page, perform the following steps:

1. Save current interrupt state and disable interrupts.
2. Set the PSEE bit (register PSCTL).
3. Set the PSWE bit (register PSCTL).
4. Write the first key code to FLKEY: 0xA5.
5. Write the second key code to FLKEY: 0xF1.
6. Using the MOVX instruction, write a data byte to any location within the page to be erased.
7. Clear the PSWE and PSEE bits.
8. Restore previous interrupt state.

Steps 4–6 must be repeated for each 512-byte page to be erased.

Notes:

1. Flash security settings may prevent erasure of some Flash pages, such as the reserved area and the page containing the lock bytes. For a summary of Flash security settings and restrictions affecting Flash erase operations, please see Section “14.3. Security Options” on page 152.
2. 8-bit MOVX instructions cannot be used to erase or write to Flash memory at addresses higher than 0x00FF.

14.1.3. Flash Write Procedure

A write to Flash memory can clear bits to logic 0 but cannot set them; only an erase operation can set bits to logic 1 in Flash. **A byte location to be programmed should be erased before a new value is written.**

The recommended procedure for writing a single byte in Flash is as follows:

1. Save current interrupt state and disable interrupts.
2. Ensure that the Flash byte has been erased (has a value of 0xFF).
3. Set the PSWE bit (register PSCTL).
4. Clear the PSEE bit (register PSCTL).
5. Write the first key code to FLKEY: 0xA5.
6. Write the second key code to FLKEY: 0xF1.
7. Using the MOVX instruction, write a single data byte to the desired location within the 1024-byte sector.
8. Clear the PSWE bit.
9. Restore previous interrupt state.

Steps 5–7 must be repeated for each byte to be written.

Notes:

1. Flash security settings may prevent writes to some areas of Flash, such as the reserved area. For a summary of Flash security settings and restrictions affecting Flash write operations, please see Section “14.3. Security Options” on page 152.
2. 8-bit MOVX instructions cannot be used to erase or write to Flash memory at addresses higher than 0x00FF.

14.2. Non-volatile Data Storage

The Flash memory can be used for non-volatile data storage as well as program code. This allows data such as calibration coefficients to be calculated and stored at run time. Data is written using the MOVX write instruction and read using the MOVC instruction. MOVX read instructions always target XRAM.

20.3.3. Software Considerations for using the SmaRTClock Timer and Alarm

The SmaRTClock timer and alarm have two operating modes to suit varying applications. The two modes are described below:

Mode 1:
The first mode uses the SmaRTClock timer as a perpetual timebase which is never reset to zero. Every 36 hours, the timer is allowed to overflow without being stopped or disrupted. The alarm interval is software managed and is added to the ALRMn registers by software after each alarm. This allows the alarm match value to always stay ahead of the timer by one software managed interval. If software uses 32-bit unsigned addition to increment the alarm match value, then it does not need to handle overflows since both the timer and the alarm match value will overflow in the same manner.

This mode is ideal for applications which have a long alarm interval (e.g., 24 or 36 hours) and/or have a need for a perpetual timebase. An example of an application that needs a perpetual timebase is one whose wake-up interval is constantly changing. For these applications, software can keep track of the number of timer overflows in a 16-bit variable, extending the 32-bit (36 hour) timer to a 48-bit (272 year) perpetual timebase.

Mode 2:
The second mode uses the SmaRTClock timer as a general purpose up counter which is auto reset to zero by hardware after each alarm. The alarm interval is managed by hardware and stored in the ALRMn registers. Software only needs to set the alarm interval once during device initialization. After each alarm, software should keep a count of the number of alarms that have occurred in order to keep track of time.

This mode is ideal for applications that require minimal software intervention and/or have a fixed alarm interval. This mode is the most power efficient since it requires less CPU time per alarm.

Internal Register Definition 20.6. RTC0XCF: SmaRTClock Oscillator Configuration

Bit	7	6	5	4	3	2	1	0
Name	AUTOSTP	LOADRDY			LOADCAP			
Type	R/W	R	R	R	R/W			
Reset	0	0	0	0	Varies	Varies	Varies	Varies

SmaRTClock Address = 0x06

Bit	Name	Function
7	AUTOSTP	**Automatic Load Capacitance Stepping Enable.** Enables/disables automatic load capacitance stepping. 0: Load capacitance stepping disabled. 1: Load capacitance stepping enabled.
6	LOADRDY	**Load Capacitance Ready Indicator.** Set by hardware when the load capacitance matches the programmed value. 0: Load capacitance is currently stepping. 1: Load capacitance has reached it programmed value.
5:4	Unused	Read = 00b; Write = Don't Care.
3:0	LOADCAP	**Load Capacitance Programmed Value.** Holds the user's desired value of the load capacitance. See Table 20.2 on page 205.

SFR Definition 22.2. SMB0CN: SMBus Control

Bit	7	6	5	4	3	2	1	0
Name	MASTER	TXMODE	STA	STO	ACKRQ	ARBLOST	ACK	SI
Type	R	R	R/W	R/W	R	R	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Page = 0x0; SFR Address = 0xC0; Bit-Addressable

Bit	Name	Description	Read	Write
7	MASTER	**SMBus Master/Slave Indicator.** This read-only bit indicates when the SMBus is operating as a master.	0: SMBus operating in slave mode. 1: SMBus operating in master mode.	N/A
6	TXMODE	**SMBus Transmit Mode Indicator.** This read-only bit indicates when the SMBus is operating as a transmitter.	0: SMBus in Receiver Mode. 1: SMBus in Transmitter Mode.	N/A
5	STA	**SMBus Start Flag.**	0: No Start or repeated Start detected. 1: Start or repeated Start detected.	0: No Start generated. 1: When Configured as a Master, initiates a START or repeated START.
4	STO	**SMBus Stop Flag.**	0: No Stop condition detected. 1: Stop condition detected (if in Slave Mode) or pending (if in Master Mode).	0: No STOP condition is transmitted. 1: When configured as a Master, causes a STOP condition to be transmitted after the next ACK cycle. Cleared by Hardware.
3	ACKRQ	**SMBus Acknowledge Request.**	0: No Ack requested 1: ACK requested	N/A
2	ARBLOST	**SMBus Arbitration Lost Indicator.**	0: No arbitration error. 1: Arbitration Lost	N/A
1	ACK	**SMBus Acknowledge.**	0: NACK received. 1: ACK received.	0: Send NACK 1: Send ACK
0	SI	**SMBus Interrupt Flag.** This bit is set by hardware under the conditions listed in Table 15.3. SI must be cleared by software. While SI is set, SCL is held low and the SMBus is stalled.	**0: No interrupt pending** 1: Interrupt Pending	0: Clear interrupt, and initiate next state machine event. 1: Force interrupt.

Table 22.5. SMBus Status Decoding With Hardware ACK Generation Disabled (EHACK = 0)

Mode	Values Read				Current SMbus State	Typical Response Options	Values to Write			Next Status Vector Expected
	Status Vector	ACKRQ	ARBLOST	ACK			STA	STO	ACK	
Master Transmitter	1110	0	0	X	A master START was generated.	Load slave address + R/W into SMB0DAT.	0	0	X	1100
	1100	0	0	0	A master data or address byte was transmitted; NACK received.	Set STA to restart transfer.	1	0	X	1110
						Abort transfer.	0	1	X	—
		0	0	1	A master data or address byte was transmitted; ACK received.	Load next data byte into SMB0DAT.	0	0	X	1100
						End transfer with STOP.	0	1	X	—
						End transfer with STOP and start another transfer.	1	1	X	—
						Send repeated START.	1	0	X	1110
						Switch to Master Receiver Mode (clear SI without writing new data to SMB0DAT).	0	0	X	1000
Master Receiver	1000	1	0	X	A master data byte was received; ACK requested.	Acknowledge received byte; Read SMB0DAT.	0	0	1	1000
						Send NACK to indicate last byte, and send STOP.	0	1	0	—
						Send NACK to indicate last byte, and send STOP followed by START.	1	1	0	1110
						Send ACK followed by repeated START.	1	0	1	1110
						Send NACK to indicate last byte, and send repeated START.	1	0	0	1110
						Send ACK and switch to Master Transmitter Mode (write to SMB0DAT before clearing SI).	0	0	1	1100
						Send NACK and switch to Master Transmitter Mode (write to SMB0DAT before clearing SI).	0	0	0	1100

25.3.3. SmaRTClock/External Oscillator Capture Mode

The Capture Mode in Timer 3 allows either SmaRTClock or the external oscillator period to be measured against the system clock or the system clock divided by 12. SmaRTClock and the external oscillator period can also be compared against each other.

Setting TF3CEN to 1 enables the SmaRTClock/External Oscillator Capture Mode for Timer 3. In this mode, T3SPLIT should be set to 0, as the full 16-bit timer is used.

When Capture Mode is enabled, a capture event will be generated either every SmaRTClock rising edge or every 8 external clock cycles, depending on the T3XCLK1 setting. When the capture event occurs, the contents of Timer 3 (TMR3H:TMR3L) are loaded into the Timer 3 reload registers (TMR3RLH:TMR3RLL) and the TF3H flag is set (triggering an interrupt if Timer 3 interrupts are enabled). By recording the difference between two successive timer capture values, the SmaRTClock or external clock period can be determined with respect to the Timer 3 clock. The Timer 3 clock should be much faster than the capture clock to achieve an accurate reading.

For example, if T3ML = 1b, T3XCLK1 = 0b, and TF3CEN = 1b, Timer 3 will clock every SYSCLK and capture every SmaRTClock rising edge. If SYSCLK is 24.5 MHz and the difference between two successive captures is 350 counts, then the SmaRTClock period is as follows:

350 x (1 / 24.5 MHz) = 14.2 µs.

This mode allows software to determine the exact frequency of the external oscillator in C and RC mode or the time between consecutive SmaRTClock rising edges, which is useful for determining the SmaRTClock frequency.

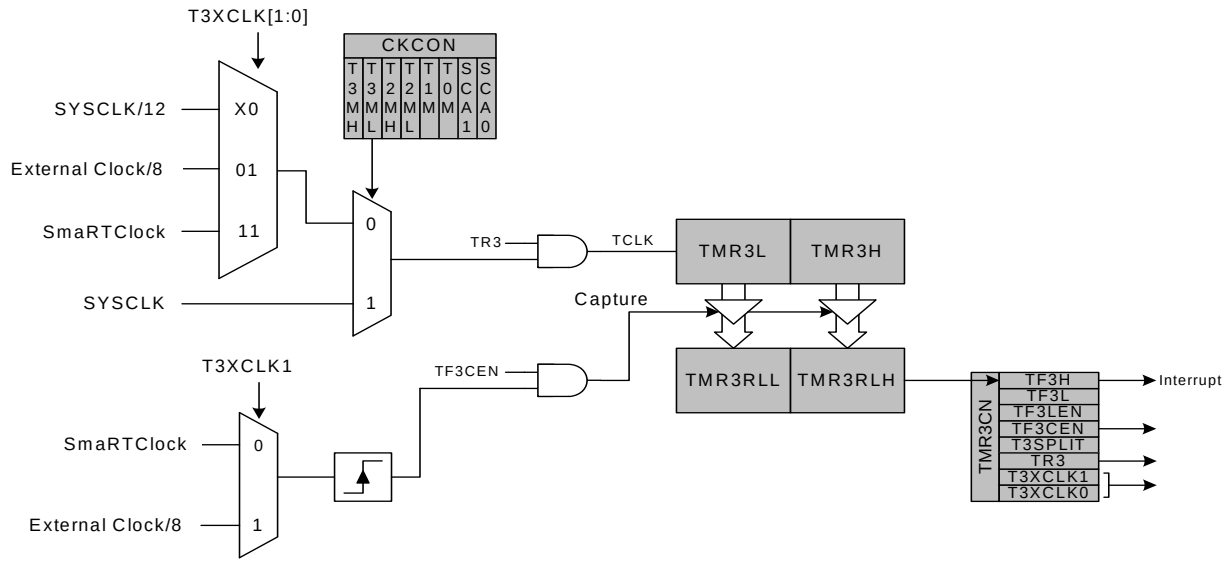


Figure 25.9. Timer 3 Capture Mode Block Diagram

26.3.6. 16-Bit Pulse Width Modulator Mode

A PCA module may also be operated in 16-Bit PWM mode. 16-bit PWM mode is independent of the other (8/9/10/11-bit) PWM modes. In this mode, the 16-bit capture/compare module defines the number of PCA clocks for the low time of the PWM signal. When the PCA counter matches the module contents, the output on CEXn is asserted high; when the 16-bit counter overflows, CEXn is asserted low. To output a varying duty cycle, new value writes should be synchronized with PCA CCFn match interrupts. 16-Bit PWM Mode is enabled by setting the ECOMn, PWMn, and PWM16n bits in the PCA0CPMn register. For a varying duty cycle, match interrupts should be enabled (ECCFn = 1 AND MATn = 1) to help synchronize the capture/compare register writes. If the MATn bit is set to 1, the CCFn flag for the module will be set each time a 16-bit comparator match (rising edge) occurs. The CF flag in PCA0CN can be used to detect the overflow (falling edge). The duty cycle for 16-Bit PWM Mode is given by Equation 26.4.

Important Note About Capture/Compare Registers: When writing a 16-bit value to the PCA0 Capture/Compare registers, the low byte should always be written first. Writing to PCA0CPLn clears the ECOMn bit to 0; writing to PCA0CPHn sets ECOMn to 1.

$$\text{Duty Cycle} = \frac{(65536 - PCA0CPn)}{65536}$$

Equation 26.4. 16-Bit PWM Duty Cycle

Using Equation 26.4, the largest duty cycle is 100% (PCA0CPn = 0), and the smallest duty cycle is 0.0015% (PCA0CPn = 0xFFFF). A 0% duty cycle may be generated by clearing the ECOMn bit to 0.

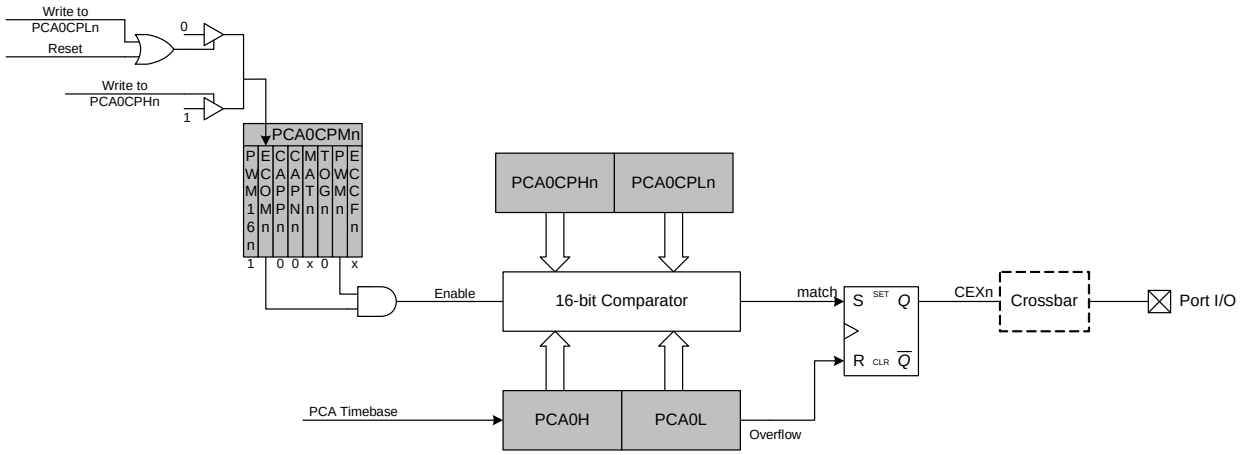


Figure 26.10. PCA 16-Bit PWM Mode